\$40.00 1209

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Michiko Kaya	04/21/2008
Hiroto Oda	04/21/2008
Teiichi Inada	04/21/2008

RECEIVING PARTY DATA

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State/Country:	JAPAN	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12092838

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ATTORNEY DOCKET NUMBER:	396.48818X00	
NAME OF SUBMITTER:	William I. Solomon	

Total Attachments: 1

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PATENT REEL: 020911 FRAME: 0132

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ASSIGNMENT

na	For good and valuable consideration, med inventor, I hereby sell and assign to $\underline{\underline{I}}$	the sufficiency and recei	pt of which is hereby acknowledged, as a below AL COMPANY, LTD.
па	1-1, Nishi-Shinjuku 2-chome		
			tle and interest, in and for the United States of
	RESIN MOLDING MA	TERIAL	
tio wh	on for United States Letters Patent therefor, ich may be granted therefor, and all divis	, executed by me even data sions, continuations and	are named below) and described in the applica- te herewith, and all United States Letters Patent extensions thereof, the said interest being the
en		en granted, to be held and	enjoyed by said HITACHI CHEMICAI
and	m for which said Letters Patent may be grame or us if this assignment and sale had not And I hereby agree to sign and executed proper in the prosecution of the above-nation.	nted, as fully and entirely been made; te any further documents med application or in the lewal, reviewed or reissue	ther legal representatives, to the full end of the as the same would have been held and enjoyed or instruments which may be necessary, lawful, preparation and prosecution of any continuing, applications or in any amendment, extension, id assignee;
	And I do hereby authorize and reques HITACHI CHEMICAL COMPA		tents to issue said Letters Patent to said
1)	APR.2 1.2008	(Full Name) Michiko KAYA	Michiko Kaya (Signature)
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Wit	iness(es)		
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RECORDED: 05/07/2008

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